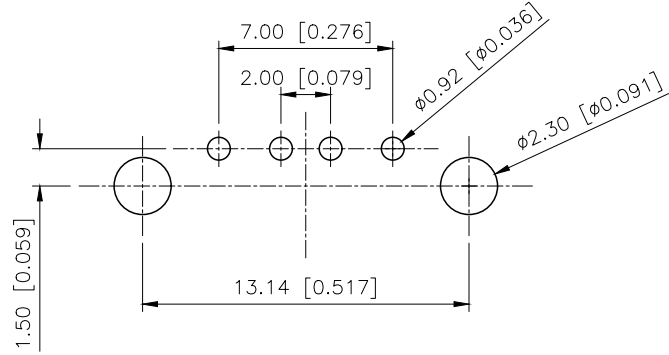
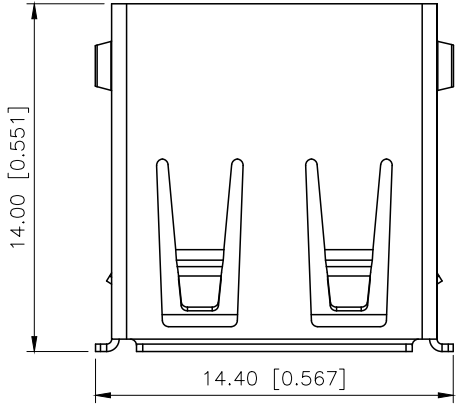


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.05.06	阿树



PCB LAYOUT

NOTES:

1.材料规格 MATERIAL SPECIFICATION:

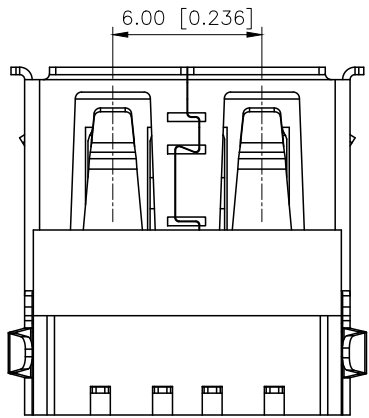
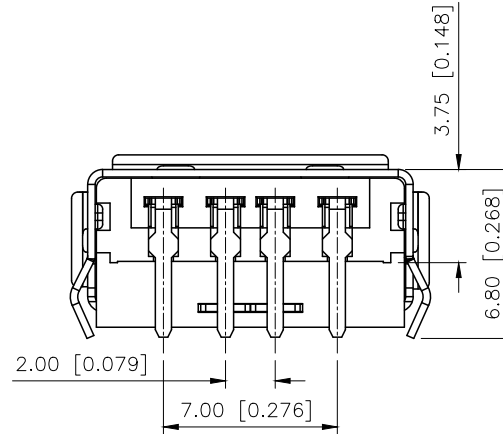
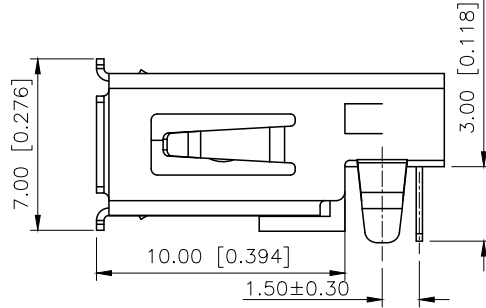
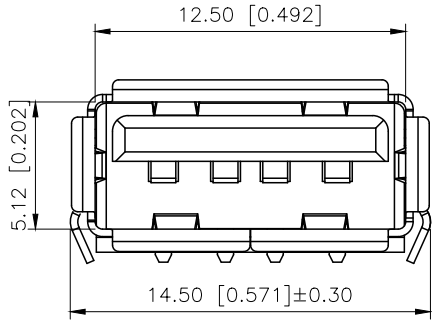
- (1) 胶壳 HOUSING MATERIAL:BLACK PBT ROHS;
- (2) 外壳 SHELL MATERIAL:SPCC T=0.30
电镀 PLATING:NICKE;
- (3) 端子 TERMINAL: C5191 T=0.25
电镀 PLATING:SEMI GOLD TIN G/F;

2.电气特性 ELECTRICAL CHARACTERISTIC:

- (1) 绝缘电阻 INSULATION RESISTANCE: 1000M Ω MIN;
- (2) 接触电阻 CONTACT RESISTANCE: 30m Ω MAX;
- (3) 耐压 WITHSTANDING VOLTAGE: 500V AC;

3.机器特性 MECHANICAL CHARACTERISTICS:

- (1) 插入力 INSERTION FORCE:3.57Kgf Max;
- (2) 拔出力 EXTRACTION FORCE:1.02Kgf Min;



U221-04XN-1BCV70-S1

1:Au 1U"
6:Au
30U"

W:WHITE
B:BLACK
1:PBT
2:PA6T
3:PA9T
4:LCP

1:SPCC 5:BRASS
S:Scrolls F:Flat

AuGLAR	$\pm 5^\circ$
X.	± 0.40
X.x	± 0.30
X.xx	± 0.20
X.xxx	± 0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树	VIEW:	MODEL TYPE: USB 2.0
CHECKED		UNIT: mm/in	PART NO.: U221-04XN-1BCV70-S1
APPROVED		SIZE: A4	DWG NO.: